Electronic Patent Application Fee Transmittal						
Application Number:	10516602					
Filing Date:	05-Jul-2005					
Title of Invention:	Method of forming a metal pattern and a method of fabricating tft array panel by using the same					
First Named Inventor/Applicant Name:	Hong-Sick Park					
Filer:	Frank Chau/Scott L Appelbaum					
Attorney Docket Number:	8071-152T					
Filed as Large Entity						
U.S. National Stage under 35 USC 371 Fil	ing Fees					
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:		'				
Pages:						
Claims:						
Miscellaneous-Filing:						
Petition:						
Patent-Appeals-and-Interference:						
Post-Allowance-and-Post-Issuance:						
Extension-of-Time:						

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	810	810				
	Total in USD (\$)			810				